

Serial No. : 2015-0385

DATE: 2015/03/31

ITEM:	CRYSTAL OSCILLATOR
TYPE :	DSB211SDN
NOMINAL FREQUENCY :	38. 400MHz
SPEC No. :	1XXD38400MMB

Please acknowledge receipt of this specification by signing and returning a copy to us.

	RECEIPT
DATE	
RECEIVED	(signature)
	(name)

General Manufacturer of Quartz Devices

DAISHINKU CORP.

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C.ENG. A. Hishikawa

ENG. 74 Takase

1. Device Name TCXO

2. Model Name DSB211SDN
3. Nominal Frequency 38.400 MHz
4. Mass 0.015g max.

5. Absolute Maximum Ratings

	Item	Symbol	Rating	unit
1	Supply Voltage	Vcc	-0.3~+4.6	V
2	Storage Temperature Range	T_ _{STG}	-40~+85	°C

6. Recommended Operating Conditions

	Item	Symbol	min.	typ.	max.	unit
1	Supply Voltage	V _{CC}	+1.71	+1.8	+1.89	V
2	Load Impedance (resistance part)	L _{OAD} _R	9	10	11	kΩ
	(parallel capacitance)	L _{OAD} _C	9	10	11	pF
3	Operating Temperature Range	T_ _{OPR}	-30	-	+85	°C

7. Electrical Characteristics

 $(T_A\text{=-}30\text{~+}85^{\circ}\text{C},\,L_{OAD}\text{_R}//\text{C}\text{=}10\text{k}\Omega//\text{10pF},\,V_{CC}\text{=+}1.8\text{V},\,\text{unless otherwise noted})$

		<u>. </u>					
	Itom	Conditions	Limits			unit	Notes
	Item	Conditions	min.	typ.	max.	unit	notes
1	Current Consumption		-	ı	+2.0	mA	
2	Output Level		8.0	ı	-	V_{P-P}	1
3	Symmetry	GND level (DC cut)	40/60	ı	60/40	%	
4	Harmonics		-	-	-5	dBc	
5	Frequency Stability						
	1.Tolerance	After 2 times reflow		_	±1.5	ppm	2,3
		Ref. to nominal frequency	-	-	±1.5	ррпп	2,3
	2.vs Temperature	T _A =-30~+85°C			±0.5	nnm	
		Ref. to frequency (T _A =+25°C)	-	-	10.5	ppm	
	3.vs Supply Voltage	V _{CC} =+1.8±5%	-	-	±0.2	ppm	
	4.vs Load Variation	L _{OAD} _R//C=(10kΩ//10pF)±10%	-	-	±0.2	ppm	
	5.vs Aging	T _A =Room ambient	-	-	±1.0	ppm/year	
6	Start Up Time	@90% of final Vout level	-	-	2.0	ms	
7	SSB Phase Noise	Relative to F0 level offset 1kHz	-	-	-125	dBc/Hz	

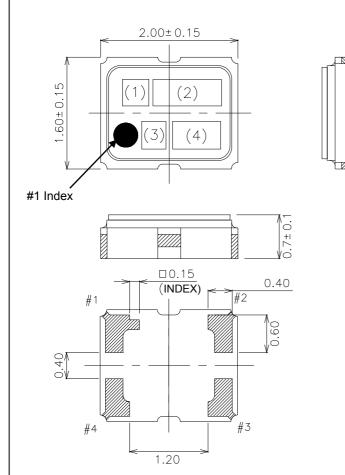
Notes

- 1. Clipped sine wave (DC-coupled)
- 2. T_A=+25°C
- 3. Please leave after reflow in 2h or more at room ambient.

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8. Outline, Pin Connections

Outline



Pin Connections

Pin No.	Connection
#1	GND
#2	GND
#3	Output
#4	V _{CC}

Marking

(1) Model code BN

(2) Frequency 38.4 (MHz, 3digits)

(3) Logo D

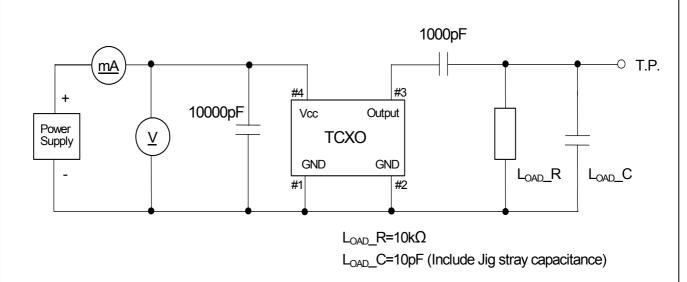
(4) Date code Year (1digit) +Week (2digits)

e.g.2015/1/1 \rightarrow 501

unit: mm

Dimensional Tolerance: ±0.1 (Unless otherwise noted)

9. Measurement Circuit



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10. Mechanical Characteristics

All test is performed after 3times reflow (Clause.13) except 10.10 (Resistance to soldering heat)

	Item Al	I test is performed after 3times reflow (Clause.13) except 1	
1		Description	Requirements
'	Drop	Natural drop (On concrete)	
		Mounting on the set or test fixture.(Total weight 100g)	
		Height : 150cm Direction : X,Y,Z, 6directions	df/f=<±1.0ppm
		Test cycle: 3cycles Peterence specification: FIA LED 4702A Method5	
2	Vibration	Reference specification : EIAJ-ED-4702A Method5	
2	Vibration	Sweep range: 10~500Hz	
		Sweep speed : 11min/cycle Amplitude : 1.5mm (10~55Hz)	
		Acceleration: 200m/s ² (55~500Hz)	df/f=<10 Ennm
		Direction: X,Y,Z, 3directions	df/f=<±0.5ppm
		Test cycle: 10cycles	
		Reference specification : IEC 60068-2-6	
3	Shock	Acceleration: 1000m/s ²	
٥	SHOCK		
		Direction : X,Y,Z, 6directions Duration : 6ms	df/f=<+0 5ppm
		Test cycle : 3cycles/each directions	df/f=<±0.5ppm
4	PCB bend	Reference specification : IEC 60068-2-27	
4	strength	PWB: t=1.6mm	df/f=<+0 5000
	Sirengin	Pressure speed: 1.0mm/s	df/f=<±0.5ppm
		Bend width : 1→2→3mm Duration : 10±1s	No visible damage.
			No leak damage.
5	Adherence nature	Reference specification : IEC 60068-2-21 Ue1 PWB : t=1.6mm	
5	Aunerence nature	Direction : X,Y, 2directions	df/f=<+0 Ennm
		Pressure: 10N	df/f=<±0.5ppm No visible damage.
		Duration: 10±1s	No leak damage.
		Reference specification : IEC 60068-2-21 Ue3	No leak damage.
6	Package strength	Pressure: 10N	df/f=<±0.5ppm
0	Fackage Silengin	Duration: 10±1s	No mechanical damage.
		Reference specification : IEC 60068-2-77	No leak damage.
7	Gross leak	It is immersed for 3min into +125±5°C	140 leak damage.
'	GIUSS IEAK	Chlorofluorocarbon (CFCs) liquid.	No continuous air bubbles.
		Reference specification : IEC 60068-2-17	140 CONTINUOUS AN DUDDICS.
8	Fine leak	It shall be measured by the helium leak detector	
0	i ilie ieak	after pressurization for 60min by the pressure	
		of (3.92±0.49) x10 ⁵ Pa in a helium gas atmosphere.	Less than 1.0x10 ⁻⁹ Pa m ³ /s.
		Reference specification: IEC 60068-2-17	
9	Solderability	Solder bath temperature : +245±5°C	A new uniform coating of solder
	Coldciability	Duration: 3±0.3s	shall cover a minimum of 95%
		Reference specification : IEC 60068-2-58	of the surface being immersed.
10	Resistance to	1) Solder iron method	o. the danged being miniciaed.
10	soldering heat	Bit size : B(φ3) Bit temperature : +350±10°C	df/f=<±0.5ppm
	John Ching Heat	Duration : 3+1/-0s /each terminal	$dV_{OUT} = < \pm 0.2V_{P-P}$
		It shall be measured after 2h at room temperature,	No visible damage.
		humidity. Reference specification : IEC 60068-2-20	Tto violble damage.
		2) Reflow	
		In refer to temperature profile shown in clause13.	df/f=<±1.0ppm
		Test cycle: 3cycles	$dV_{OUT} = < \pm 0.2V_{P-P}$
		It shall be measured after 2h at room temperature,	No visible damage.
		humidity. Reference specification: IEC 60068-2-58	110 Violbie dailiage.
	l	namiany. Neicronice specimeation . ILO 00000-2-30	

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11. Environmental Characteristics

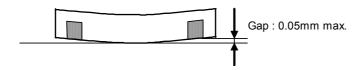
All test is performed after 3times reflow (Clause13)

	Item	Description	Requirements
1	Low temperature	Temperature : -40±3°C	df/f=<±1.0ppm
	storage	Duration: 1000h	$dV_{OUT} = < \pm 0.2V_{P-P}$
	, ,	It shall be measured after 2h at room temperature,	The electrical characteristics
		humidity. Reference specification : IEC 60068-2-1 Ab	are satisfied.
2	High temperature	Temperature : +85±2°C	df/f=<±1.0ppm
	storage	Duration: 1000h	$dV_{OUT} = < \pm 0.2V_{P-P}$
		It shall be measured after 2h at room temperature,	The electrical characteristics
		humidity. Reference specification : IEC 60068-2-2 Bb	are satisfied.
3	Humidity	Temperature : +85±2°C	df/f=<±1.0ppm
		R.H. 85±5%	$dV_{OUT} = < \pm 0.2V_{P-P}$
		Duration: 1000h	The electrical characteristics
		It shall be measured after 2h at room temperature,	are satisfied.
		humidity. Reference specification : IEC 60068-2-3	are satisfied.
4	HTB	Temperature : +85±2°C	df/f=<±1.0ppm
		Duration: 1000h	dV _{OUT} =<±0.2V _{P-P}
		BIAS : Max value of supply voltage	The electrical characteristics
		It shall be measured after 2h at room temperature,	are satisfied.
		humidity. Reference specification : IEC 60068-2-2 Bb	are dationed.
5	THB	Temperature : +40±2°C	
		R.H. 90~95%	df/f=<±1.0ppm
		Duration: 1000h	$dV_{OUT} = < \pm 0.2V_{P-P}$
		BIAS : Max value of supply voltage	The electrical characteristics
		It shall be measured after 2h at room temperature,	are satisfied.
		humidity. Reference specification : IEC 60068-2-3	
6	Thermal shock	Thermal shock : $-40\pm3^{\circ}$ C : 0.5h \Leftrightarrow $+85\pm2^{\circ}$ C : 0.5h	df/f=<±1.0ppm
		Test cycle : 200cycles	dV _{OUT} =<±0.2V _{P-P}
		Shift time : 2~3min	The electrical characteristics
		It shall be measured after 2h at room temperature,	are satisfied.
		humidity. Reference specification : IEC pub.68-2-14.Na	
7	ESD	Model : Machine Model (MM)	
		V=±200V (C1=200pF, R1=0Ω)	df/f=<±1.0ppm
		Number of times : 3times	$dV_{OUT} = < \pm 0.2V_{P-P}$
		Each terminal except common terminal.	The electrical characteristics
		(Connect to test terminal)	are satisfied.
		Reference specification : EIA/JESD22-A114	
		Model : Human Body Model (HBM)	
		V=±1500V (C1=100pF, R1=1500Ω)	df/f=<±1.0ppm
		Number of times : 3times	$dV_{OUT} = < \pm 0.2V_{P-P}$
		Each terminal except common terminal.	The electrical characteristics
		(Connect to test terminal)	are satisfied.
		Reference specification : EIA/JESD22-A115	

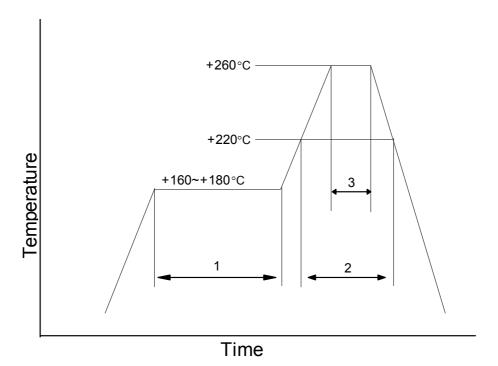
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12. Flatness of Terminal

When the component is placed on the flat surface, the gap from the connecting terminal shall not exceed 0.05 mm.



13. Reflow Profile



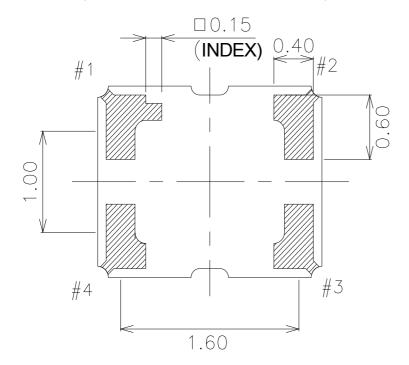
1	Preheat	+160~+180°C	120s
2	Primary Heat	+220°C	60s
3	Peak	+260°C	10s max.

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14. Terminals / Land Pattern Layout / Metal Mask Hole

14.1 Terminals

A through hole is not located on the bottom (mounting side).



unit: mm

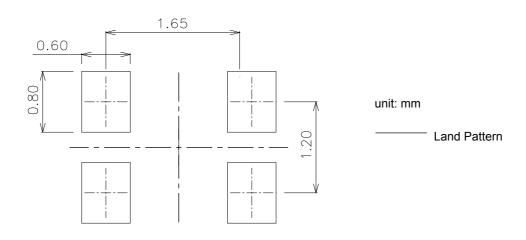
Dimensional Tolerance: ±0.15mm



Mounting Terminal

14.2 Land Pattern Layout / Metal Mask Hole

The following land pattern is reference design. The electrical characteristic shall be satisfied with mounting to this land. The land pattern can be changed in the limits to which a test land and a mounting land are not connected. And it does not any effect to the electrical characteristics. Mask thickness recommends 0.12mm.



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15. Packing Condition

- 15.1 Taping package
 - (1) Emboss tape format and dimensions

See Fig.1

- (2) Quantity on reel 2000pcs. max. / reel
- (3) Taping specification

See Fig.2

No lack of a product.

(4) Reel specification See Fig.3

(5) Taping material list See right table.

15.2 Packing

The products packed in the antistatic bag.

*Moisture sensitivity level: IPC/JEDEC Standard J-STD-033 / Level 1

No dry pack required and baking after re-storage is unnecessary.

15.3 Packing box

Max 10 reels/packing box. However, in the case of less than 10 reels, It is contained by any boxes.

The space in a box is fill up with a cushion.

15.4 Label detail

A Lot label is put on a reel and a shipping label and Pb-Free label is put on a packing box.

Lot label

TYPE (Model Name)
SPEC NO. (Spec. Number)
PARTS NO. (User's Parts Number)
LOT NO. (Lot Number)
FREQ. (Nominal Frequency)
Q'TY (Quantity)
KDS DAISHINKU CORP.

Shipping label

ITEM (Model Name)
SPEC (Spec. Number)
DELIVERY DATE (Delivery Date)
Q'TY (Quantity)
NOTES (User's Parts Number)
DAISHINKU CORP.

Taping material List

Emboss: PS (Conductivity)

Reel: PS (Conductivity)

Cover Tape: PET + Olefin Resin (Conductivity)

Pb-free Label



Lot label (Example)

Formation of a lot number

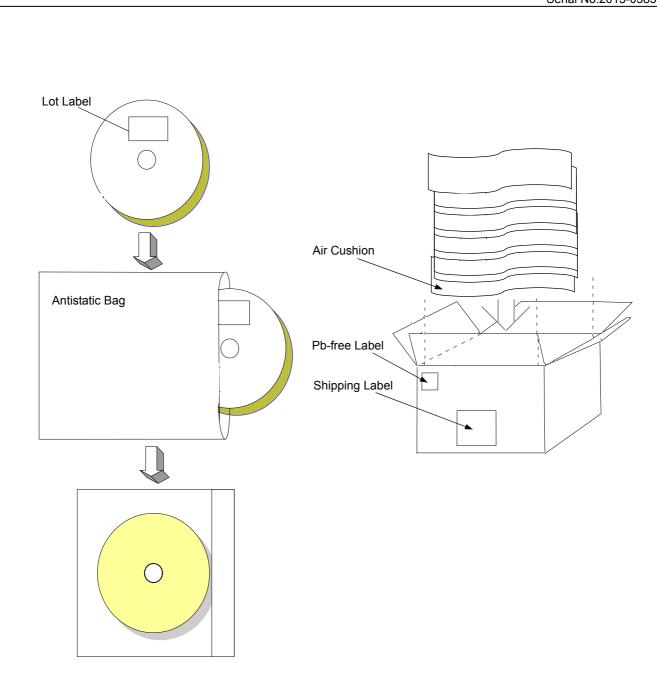
e.g. AH5101001

The notation method of a manufacture year, month, and day. (4digits alphanumeric character)

YMDD (4digits) e.g.) 2015 /01 /01→ 5101
 Year 1digit (Last digit of Year)
 Month 1digit alphanumeric symbol
 DD Day 2digits numerical characters of day

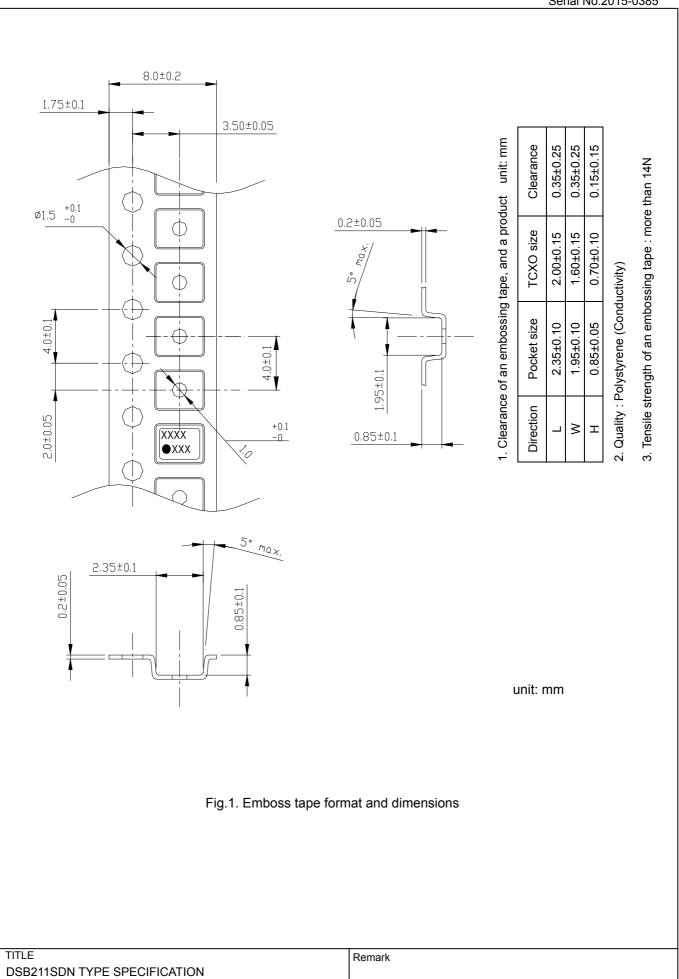
Month	Jan.	Feb.	Mar.	Apr.	Мау.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Symbol	1	2	3	4	5	6	7	8	9	0	Ν	D

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The product is packed up with the method which does not break in the handling by a shipping agent.

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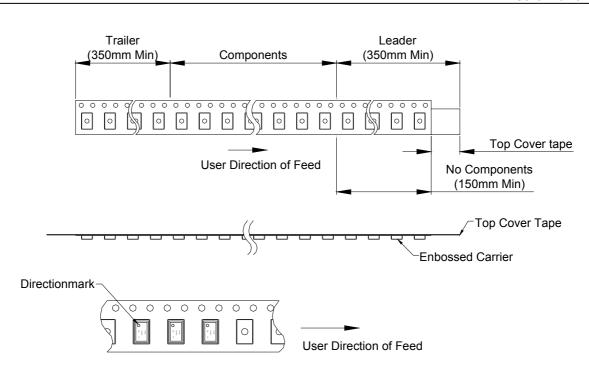
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When a tape end is taken out to the front, sprocket holes becomes right hand side.

Peel strength

Pulling angle 165~180°, pulling speed at 300mm/min, strength should be 0.2~0.7N.

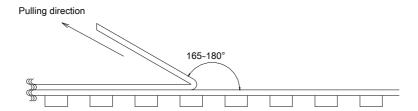
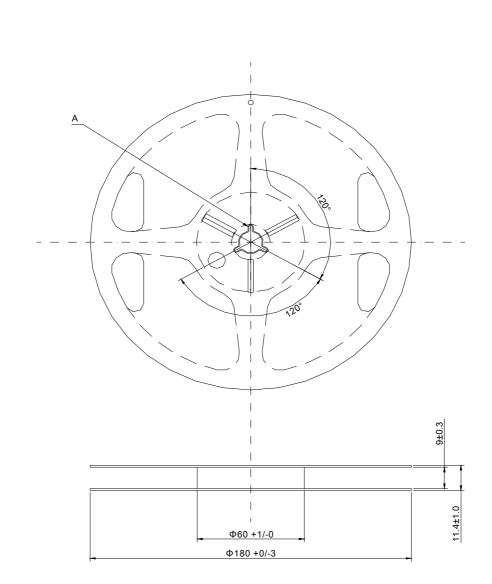


Fig.2. Taping specification

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Material:Polystyrene (Conductivity) unit:mm

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Section A

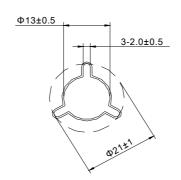


Fig.3. Reel specification

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16. Notes on mounting and handling

- 16.1 Storage environment
 - (1) The temperature and humidity of a storage place, Please give +5~+40°C and 40~85% as a standard.
 - (2) Please use this product within one year from the packing label date of issue.
 - (3) Please avoid the place which generates corrosive gas, and the place with much dirt.
 - (4) Please keep it in a place with little temperature change.

Dew condensation arises owing to a rapid temperature change and solderability becomes bad.

- 16.2 Be cautions to static electricity and high voltage.
- 16.3 This product has sufficient durability to fall and vibration. However, conditions may change to the fall after mounting to a PWB, and vibration. When you should drop on a floor the PWB which mounted the product or too much shock is added. Please use after a performance check.
- 16.4 Please check that the curvature of the substrate at the time of substrate cutting does not affect product. Moreover, especially when a product is near the position of a PWB guide pin, and the position of PWB break, be careful.
- 16.5 The part concerned does not correspond to washing.
- 16.6 Please repair at +260°C in 10s with hot air or +350°C in 5s with solder Iron.

17. Mandatory control

17.1 Ozone-depleting substance

It regulates by the U.S. air purifying method (November, 1990 establishment). ODS of CLASS1 and CLASS2 is not contained or used.

17.2 PBDE, PBBs

PBDE, PBBs are not contained into all the material currently used for this product.

17.3 RoHS

Following material restricted by RoHS (2011/65/EU) is not included or used. Lead, mercury, cadmium, hexavalent, chromium, PBB and PBDE.

17.4 Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances

All the material currently used for this product is based on "Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances". It is a registered material.

17.5 Lead

Leads, such as solder, are not used for this product. (Lead Free)

17.6 About the existence of silver and mercury use

The silver of very small quantity is contained in the conductive adhesives used for adhesion of Blank.

Moreover, mercury is used. It does not get down.

18. The country of origin / factory name / address

Country of origin: Japan

Factory name: DAISHINKU Corp. Tottori Production Div.
Address: 7-3-21 Wakabadai minami, Tottori 689-1112

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2015-0385 REVERSION RECORD

Rev. No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2015/03/31	-	Initial Release	A.Hishikawa	H.Takase	S.Fujihira

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